

### APPLICATION DATA SHEET

## INVENTOR INFORMATION

Inventor one given name::

Koki

Family name::

**ISHIZAKI** 

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c/o Hitachi, Ltd., Intellectual Property Group

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New Marunouchi Bldg.

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State or Province::

Country::

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City of residence:: Country of residence:: Hitachinaka-shi Japan

Citizenship Country::

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Inventor two given name::

Takeshi

Family name::

**SHIRATO** 

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City of residence::

Hitachinaka-shi

Country of residence::

Japan

Citizenship Country::

Japan

## CORRESPONDENCE INFORMATION

Correspondence customer number:: 23911

### APPLICATION INFORMATION

Title line one:: Title line two::

THE MULTILAYER ELECTRONIC SUBSTRATE, AND THE METHOD OF

Title line three::

MANUFACTURING MULTILAYER

Title line four::

**ELECTRONIC SUBSTRATE** 8

Total drawing sheets::

Yes

Formal drawings?::

-1-

Application type::
Docket Number::

Utility

056203.52845US

# REPRESENTATIVE INFORMATION

Representative customer number:: 23911

# PRIOR FOREIGN APPLICATIONS

Foreign application one::

2002-302229

Filing date::

October 16, 2002

Country::

Japan

Priority claimed::

Yes